



# Product data sheet

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DB101S-DB107S HF

Semiconductor Compiance

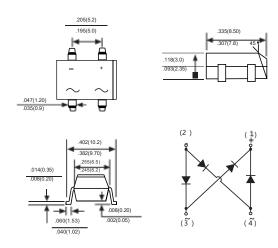
### Features

Ideal for printed circuit board

Reliable low cost construction utilizing molded plastic technique High temperature soldering guaranteed: 260°/10 seconds at 5 lbs., (2.3kg) tension

Small size, simple installation

High surge current capability



## Mechanical Data

Case : JEDEC DBS Molded plastic body Terminals : Solder plated, solderable per MIL-STD-750, Method 2026 Polarity : Polarity symbol marking on case Mounting Position : Any Weight : 0.02 ounce, 0.4 grams

Dimensions in inches and (millimeters)

#### **REEL SPECIFICATION**

P/N	PKG	QTY
DB101S-DB107S	DBS	1500

## **Maximum Ratings And Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwisespecified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	S <b>DB101S</b>	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	UNITS
Marking Code	SYMBOLS								
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_{\text{C}}\text{=}40^{\circ}\text{C}$		1.0						А	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)		50							А
Maximum instantaneous forward voltage drop per leg at 1A	Vf	1.1						V	
Maximum DC reverse currentT_A=25°Cat rated DC blocking voltageT_A=100°C	lR	lR 10 500				μA μA			
Operating temperature range		-55 to +150						°C	
storage temperature range		-55 to +150						°C	

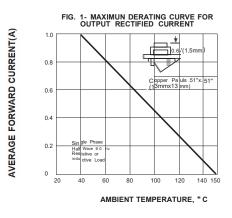
NOTES:DBS for surface mount package.

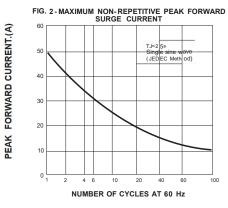


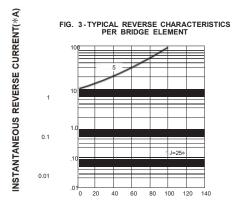
DB101S-DB107S HF 🐼

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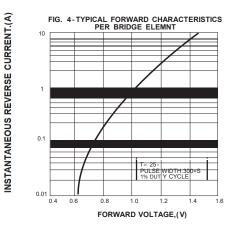
#### atings And Characteristic Curves



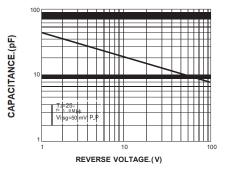




PERCENT OF RATED PEAK REVERSE VOLTAGE.(%)









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